

NSYDLM112

Modular chassis DLM type for SPACIAL WM enclosure, 112 modules, H800xW600mm.



Main

Range	Spacial
Accessory / separate part category	Mounting accessory
Device application	Multi-purpose Modular distribution application
Product or component type	Chassis
Device short name	DLM
Enclosure nominal dimensions	
Mounting location	Step slide Front of enclosure
Range compatibility	Spacial CRN Spacial S3D Spacial S3X
Device composition	1 chassis structure 4 front panels with 35 mm DIN rail 2 finish cover 1 neutral/earth strip 2 x 16 mm ² 5 x 6 mm ²
Quantity per set	Set of 1

Complementary

Material	Steel
Colour	Front panel : grey RAL 7035
Surface finish	Polyester powder
Fixing mode	By fixing element - on front and back with supports location
Adjustment	In height from 40 to 85 mm for DIN rail
Number of horizontal rows	4
Total number of 18 mm modules	112
Type of front plate	Plain and cut-out plates
Number of cut-out	4 cut-outs
Height	753 mm
Width	555 mm
Depth	101.5 mm

Environment

Offer Sustainability

Sustainable offer status	Green Premium product
RoHS (date code: YYWW)	Compliant - since 0940 - Schneider Electric declaration of conformity
REACH	Reference not containing SVHC above the threshold
Product environmental profile	Available
Product end of life instructions	Need no specific recycling operations

Contractual warranty

Warranty period	18 months
-----------------	-----------

The information provided in this documentation contains general descriptions and/or technical characteristics of the products contained herein. This documentation is not intended as a substitute for and is not to be used for determining suitability or reliability of these products for specific user applications. It is the duty of any such user or integrator to perform the appropriate and complete risk analysis, evaluation and testing of the products with respect to the relevant specific application or use thereof. Neither Schneider Electric Industries SAS nor any of its affiliates or subsidiaries shall be responsible or liable for misuse of the information contained herein.